

Product Summary

Portable electronics

R_{DS(on)}

495mΩ @ V_{GS} = -4.5V

 $690m\Omega @ V_{GS} = -2.5V$

960mΩ @ V_{GS} = -1.8V

ideal for high efficiency power management applications.

This MOSFET has been designed to minimize the on-state resistance

(R_{DS(on)}) and yet maintain superior switching performance, making it

Description and Applications

V(BR)DSS

-20V



A Product Line of **Diodes Incorporated**

DMP21D0UFB4

20V P-CHANNEL ENHANCEMENT MODE MOSFET

Features and Benefits

- Footprint of just 0.6mm² thirteen times smaller than SOT23 •
- 0.4mm profile ideal for low profile applications
- Low Gate Threshold Voltage
- Fast Switching Speed
- "Lead Free", RoHS Compliant (Note 1)
- Halogen and Antimony Free. "Green" Device (Note 2)
- **ESD Protected Gate 3KV**
- Qualified to AEC-Q101 Standards for High Reliability

Mechanical Data

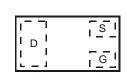
- Case: DFN1006H4-3 •
- Case Material: Molded Plastic, "Green" Molding Compound. • UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Finish NiPdAu over Copper leadframe. Solderable per MIL-STD-202, Method 208
- Weight: 0.001 grams (approximate)





DFN1006H4-3

Bottom View



Top View

Internal Schematic

Gate 0 Gate Protection Source Diode Equivalent Circuit

Drain

Ordering Information (Note 3)

Part Number	Marking	Reel size (inches)	Tape width (mm)	Quantity per reel
DMP21D0UFB4-7B	NO	7	8	10,000

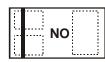
Notes: 1. No purposefully added lead

2. Diodes Inc's "Green" policy can be found on our website at http://www.diodes.com.

3. For packaging details, go to our website at http://www.diodes.com.

Marking Information

DMP21D0UFB4-7B



NO = Product Type Marking Code

Top View Bar Denotes Gate and Source Side



I_D @ T_A = 25°C

-0.77A

-0.67A

-0.57A





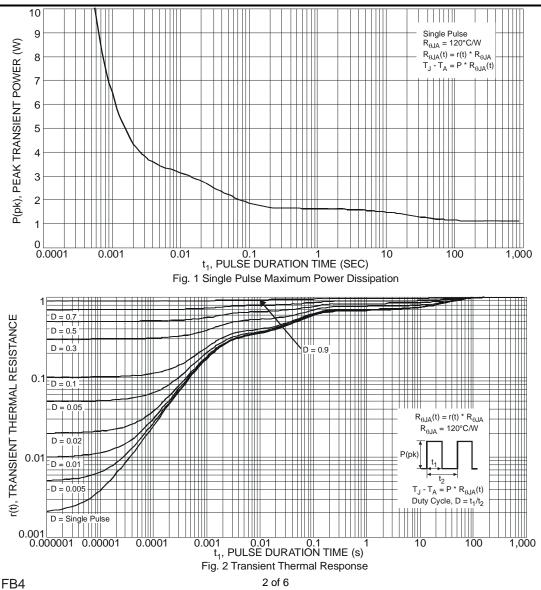
Maximum Ratings @T_A = 25°C unless otherwise specified

Characteristic		Symbol	Value	Unit	
Drain-Source Voltage			V _{DSS}	-20	V
Gate-Source Voltage		V _{GSS}	±8	V	
Continuous Drain Current	Steady State	$T_A = 25^{\circ}C$ (Note 4) $T_A = 85^{\circ}C$ (Note 4) $T_A = 25^{\circ}C$ (Note 5)	I _D	-0.77 -0.55 -1.17	A
Pulsed Drain Current (Note 6)			I _{DM}	-5.0	A

Thermal Characteristics @T_A = 25°C unless otherwise specified

Characteristic	Symbol	Value	Unit
Power Dissipation (Note 4)	PD	0.43	W
Power Dissipation (Note 5)	PD	0.99	W
Thermal Resistance, Junction to Ambient (Note 4)	R _{0JA}	293	°C/W
Thermal Resistance, Junction to Ambient (Note 5)	R _{0JA}	126	°C/W
Operating and Storage Temperature Range	TJ, TSTG	-55 to +150	°C

Thermal Characteristics



DMP21D0UFB4 Datasheet number: DS35279 Rev. 2 - 2 www.diodes.com





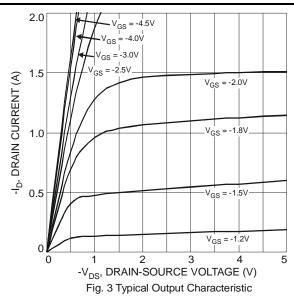
Electrical Characteristics @T_A = 25°C unless otherwise specified

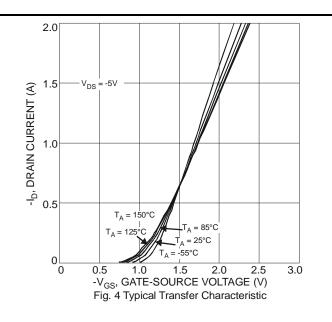
Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition
OFF CHARACTERISTICS (Note 7)	Symbol	IVIIII	тур	Wax	Unit	Test condition
Drain-Source Breakdown Voltage	D\/	20	-	-	V	$V_{22} = 0 V_{22} = 250 u A$
,,	BV _{DSS}	20	-	-1		$V_{GS} = 0V, I_D = -250\mu A$
Zero Gate Voltage Drain Current $T_J = 25^{\circ}C$	I _{DSS}	-		•	μA	$V_{DS} = -20V, V_{GS} = 0V$
Gate-Source Leakage	I _{GSS}	-	-	±10	μA	$V_{GS} = \pm 8V, V_{DS} = 0V$
ON CHARACTERISTICS (Note 7)	<u> </u>					h
Gate Threshold Voltage	V _{GS(th)}	-	-0.7	-	V	$V_{DS} = V_{GS}, I_D = -250 \mu A$
				495		$V_{GS} = -4.5V, I_D = -400mA$
Static Drain-Source On-Resistance	R _{DS (ON)}	-	-	690	mΩ	$V_{GS} = -2.5V, I_D = -300mA$
				960		$V_{GS} = -1.8V, I_D = -100mA$
Forward Transfer Admittance	Y _{fs}	50	-	-	mS	$V_{DS} = -3V, I_D = -300mA$
Diode Forward Voltage	V _{SD}	-	-	-1.2	V	$V_{GS} = 0V, I_{S} = -300mA$
DYNAMIC CHARACTERISTICS						
Input Capacitance	C _{iss}	-	80	-	pF	− V _{DS} = -10V, V _{GS} = 0V, − f = 1.0MHz
Output Capacitance	C _{oss}	-	15.5	-	pF	
Reverse Transfer Capacitance	C _{rss}	-	10.4	-	pF	
Gate Resistance	R _g	-	599.2	-	Ω	$V_{DS} = 0V$, $V_{GS} = 0V$, $f = 1MHz$
Total Gate Charge	Qg		1.54	-	nC	$V_{GS} = -8V, V_{DS} = -15V, I_D = -1A$
Total Gate Charge	Qg	-	0.91	-	nC	
Gate-Source Charge	Q _{qs}	-	0.14	-	nC	$V_{GS} = -4.5V, V_{DS} = -15V,$
Gate-Drain Charge	Q _{gd}	-	0.24	-	nC	$I_D = -1A$
Turn-On Delay Time	t _{D(on)}	-	6.7	-	ns	
Turn-On Rise Time	tr	-	9.2	-	ns	$V_{DS} = -10V, -I_{D} = 1A$
Turn-Off Delay Time	t _{D(off)}	-	49.2	-	ns	$V_{GS} = -4.5V, R_{G} = 6\Omega$
Turn-Off Fall Time	t _f	-	34.5	-	ns	

4. Device mounted on FR-4 substrate PC board, 2oz copper, with minimum recommended pad layout Notes:

5. Device mounted on FR-4 substrate PC board, 202 copper, with thermal vias to bottom layer 1inch square copper plate 6. Device mounted on minimum recommended pad layout test board, 10 μ s pulse duty cycle = 1%. 7. Short duration pulse test used to minimize self-heating effect.

Typical Characteristics

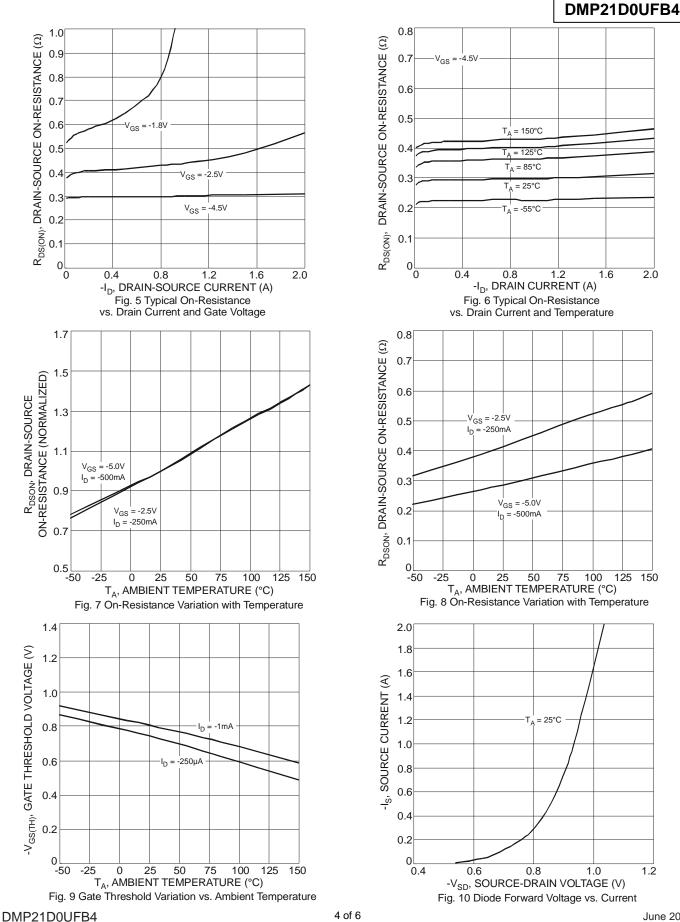






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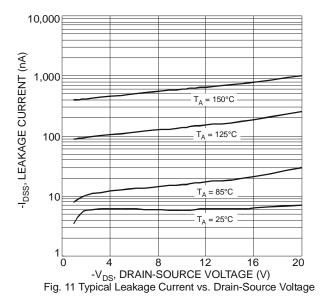
Datasheet number: DS35279 Rev. 2 - 2

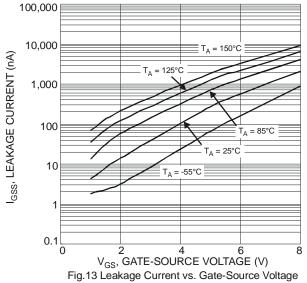


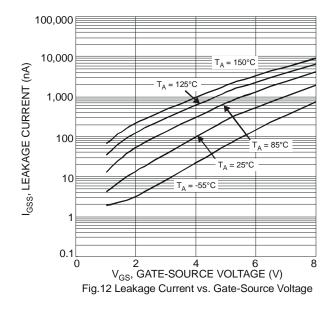
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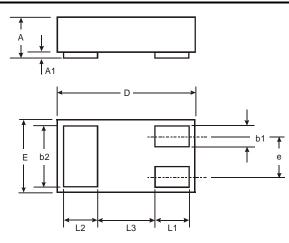








Package Outline Dimensions

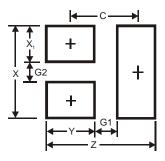


DFN1006H4-3					
Dim	Min	Max	Тур		
Α		0.40			
A1	0	0.05	0.02		
b1	0.10	0.20	0.15		
b2	0.45	0.55	0.50		
D	0.95	1.075	1.00		
Е	0.55	0.675	0.60		
е	_	_	0.35		
L1	0.20	0.30	0.25		
L2	0.20	0.30	0.25		
L3			0.40		
All	All Dimensions in mm				





Suggested Pad Layout



Dimensions	Value (in mm)	
Z	1.1	
G1	0.3	
G2	0.2	
Х	0.7	
X1	0.25	
Y	0.4	
С	0.7	

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